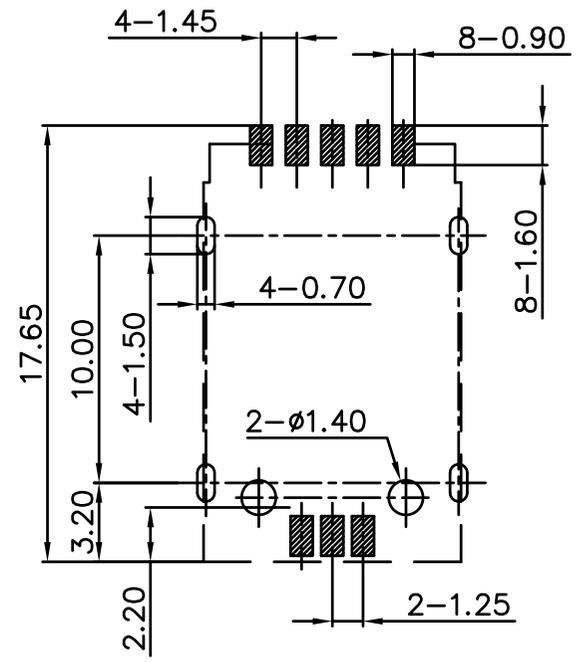
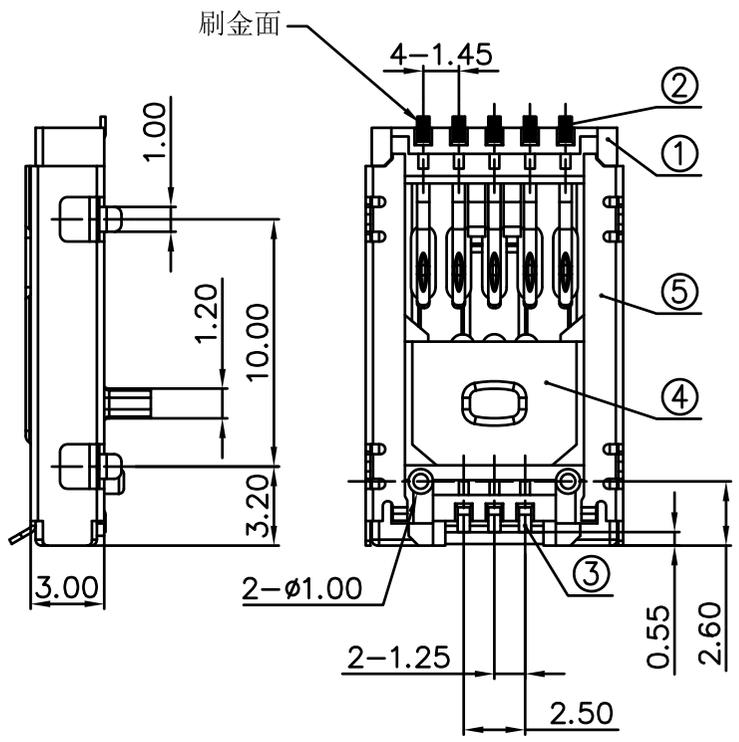
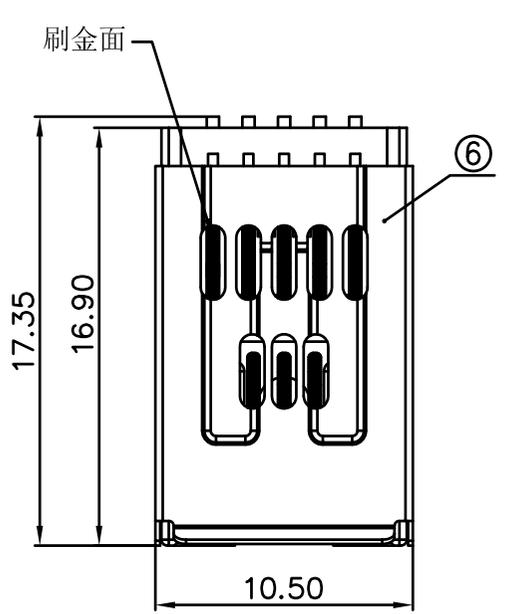
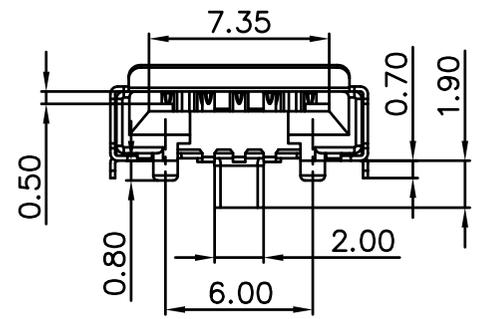


RoHS

5	6	7	8
ECN NO.	REV	DATE	DESCRIPTION



PCB Layout Diagram  
Top View



⑤	COVER	1	SUS T=0.20mm	
④	SLIDER	1	LCP	BLACK
③	TERMINAL2	3	PHOSPHOR BRONZE, T=0.20mm	Gold Plating and Ni Under-Plating
②	TERMINAL1	5	PHOSPHOR BRONZE, T=0.20mm	Gold Plating and Ni Under-Plating
①	HOUSING	1	LCP	BLACK

NO.	PART NAME	Q'TY	MATERIAL	PLATING & COLOR
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UNLESS OTHERWISE SPECIFIED TOLERANCES					厦门宏端电子科技有限公司				
DECIMALS: X		ANGLES: X		DSND	LQ.HUANG	DATE	2024-03-16	TITLE:	
X.X :±0.30		X.X :±1°		CHKD		DATE		8P 血糖仪	
X.XX :±0.25		X.XX :±0.5°		APVD	XY.XUE	DATE	2024-03-16	PART NO.:	
X.XXX :±0.20		X.XXX :±0.10		WEIGHT:				XTY-8P-001	
SHEET 1 OF 1		SCALE:3.5:1		SIZE:A4	VIEW:				
UNIT:mm		REV.:A/0		OBJECT:MY	DRAW NO.:MY-CP-0107				